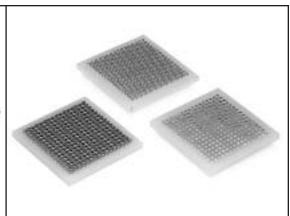
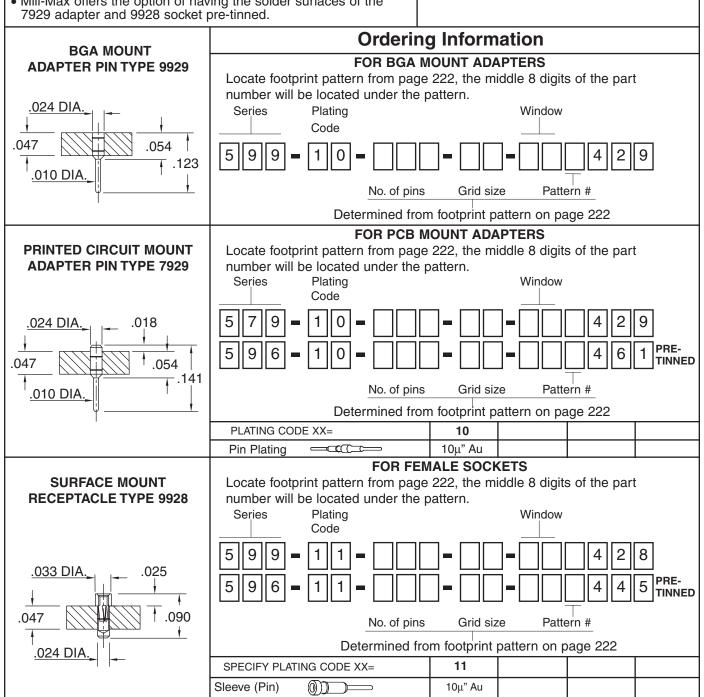


## **BALL GRID ARRAYS** For 1mm Grid Male Pin Adapters & Female Socket

- BGA adapter/socket systems are a reliable way to make BGAs pluggable, they may also be used as a high density board-to-board interconnect.
- The BGA device is soldered to a 9929 adapter (or a 7929 adapter is soldered to a PCB); and then either one can be plugged into a 9928 surface mount socket.
- Both socket and adapter have the same footprint as the BGA device.
- Insertion force is only .41N per pin, and a pry-bar tool (part #828-01-010) is available for extraction.
- Insulator material is FR-4 epoxy having a TCE to match the BGA device and circuit board.
- Mill-Max offers the option of having the solder surfaces of the 7929 adapter and 9928 socket pre-tinned.





 $\cap \geq$ 

10μ" Au

Contact (Clip)



## **BALL GRID ARRAY FOOTPRINTS (1mm GRID)**

Top view shown, many other standard and custom footprints available.

Call Mill-Max for details.

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		X 8 10 X 10 064-04-000 XXX-XX-100-05-000					14 X 14 XXX-XX-196-07-000
					22 X 22		
16 X 16 XXX-XX-208-08-001		X 16	18 X 18	22 X 22 XXX-XX-324-11-005			22 X 22 XXX-XX-484-11-005
888888888888888888888888888888888888888				888888888888888888888888888888888888888		000000000000000000000000000000000000000	
26 X 26		26 X 26		26 X 26		26 X 26	
XXX-XX-352-13-007		XXX-XX-388-13-007		XXX-XX-484-13-005		XXX-XX-672-13-005	
26 X 26		26 X 26		30 X 30		33 X 33	
XXX-XX-675-13-005		XXX-XX-676-13-000		XXX-XX-432-15-001		XXX-XX-560-17-001	
34 X 34		34 X 34		39 X 39		39 X 39	
XXX-XX-580-17-005		XXX-XX-680-17-005		XXX-XX-560-20-007		XXX-XX-680-20-005	